



HP Elite t655 Thin Client Bundle (6R0Q1AA)



Overview

One of the best thin clients from HP for versatility and performance with robust security and productivity features.

The flexible performance options of the HP Elite t655 Thin Client enables workforce productivity, while commercial-grade security features provide IT peace of mind. Built to support demanding performance requirements, this device helps end users tackle daily tasks, while versatile configuration options help optimize workspaces.

Refined security

The HP Elite t655 Thin Client features multi-layered security with AMD Memory Guard, an embedded OS, and more.

Built for productivity

Enhance performance with a next gen AMD Ryzen™ Embedded R-Series processor[1] and up to three UHD/4K displays.[5]

Flexible configurations

Create a functional workspace with docking displays and stations, and select peripheral devices.[4]

[1] Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.

[4] Peripherals sold separately or as optional features. Compatible with HP E24m G4 FHD USB-C Conferencing Monitor, HP E24u G4 FHD USB-C Monitor, HP E27u G4 QHD USB-C Monitor, HP E27m G4 QHD USB-C Conferencing Monitor, and HP USB-C Dock G5.

[5] 4K content required to view 4K images. Displays sold separately and not included.

Specifications

Operating system	Windows 10 IoT Enterprise
Memory	8 GB DDR4-3200 SDRAM (2 x 4 GB)
Memory Slots	2 SODIMM
Internal Storage	64 GB eMMC
Audio	Internal amplified speaker system for basic audio playback
Minimum dimensions (W x D x H)	3.5 x 20 x 20 cm (Vertical orientation.)
Minimum dimensions (W x D x H)	1.38 x 7.87 x 7.87 in (Vertical orientation.)
Weight	1.12 kg (without stand); 1.17 kg (with stand) (Weight will vary depending on configuration.)
Weight	2.5 lb (without stand); 2.6 lb (with stand) (Weight will vary depending on configuration.)
Keyboard	HP USB Keyboard
Pointing device	HP USB Mouse
Ports	1 SuperSpeed USB Type-A 5Gbps signaling rate; 1 SuperSpeed USB Type-A 10Gbps signaling rate; 1 3.5 mm audio jack
Ports	1 audio-in/out; 1 RJ-45; 2 SuperSpeed USB Type-A 5Gbps signaling rate; 2 SuperSpeed USB Type-A 10Gbps signaling rate; 3 DisplayPort™ 1.2
Protocols	Citrix® HDX; Microsoft RFX/RDP; VMware Horizon® through RDP/PCoIP
Power	45 W smart external power adapter
Ecolabels	EPEAT® registered
Sustainable impact specifications	Low Halogen
Software included	HP Device Manager; HP Easy Shell; HP Easy Tools; HP ThinUpdate; HP True Graphics; HP Cloud Endpoint Manager; Microsoft AVD; HP Write Manager ^[10,11]
Browser supported	Mozilla Firefox (for models with HP ThinPro); Microsoft Edge (for models with Windows 10 IoT Enterprise LTSC 2021)
UPC number	(A2K) 196786411854; (A2N) 196786411212; (AB0) 196786411847; (AB1) 196786411861; (AB2) 196786411878; (AB4) 196786411885; (AB6) 196786411229; (AB7) 196786411236; (AB8) 196786411243; (AB9) 196786411250; (ABA) 196786411175; (ABB) 196786411267; (ABC) 196786411182; (ABD) 196786411281; (ABE) 196786411274; (ABF) 196786411298; (ABG) 196786411892; (ABH) 196786411311; (ABJ) 4573595804767; (ABM) 196786411199; (ABN) 196786411304; (ABT) 196786411335; (ABU) 196786411328; (ABV) 196786411342; (ABY) 196786411359; (ABZ) 196786411366; (AC4) 196786411205; (ACB) 196786411380; (ACF) 4573595804750; (ACJ) 196786412684; (ACQ) 196786411373; (AK8) 196786411397; (AKC) 196786411403; (AKL) 196786411915; (AKS) 196786411410; (AR6) 196786411922; (BCM) 196786411427; (UUG) 196786411823; (UUQ) 197029359490; (UUZ) 196786411830

Additional specifications

Certifications and compliances	EMC; EN 60601-1-2
I/O Port location	Front
I/O Port location	Back
Keyboard interface	USB
Memory layout (slots & size)	2 x 4 GB
Memory module type	SODIMM
Memory size	8
Memory size uom	GB
Memory speed	3200
Memory speed uom	MHz
Memory type	DDR4
Number of memory slots	2
Product long name specifications	HP Elite t655 Thin Client Bundle, Windows 10 IoT Enterprise, 8GB RAM, 64GB eMMC
Product short name specifications	HP Elite t655 Thin Client Bundle, 8GB RAM, 64GB eMMC
Standard memory note	Transfer rates up to 3200 MT/s.
Storage capacity	64
Storage capacity uom 01	GB
Storage type	eMMC
Storage type 01	eMMC
UNSPSC code	43211506

[10] HP Easy Shell is currently available on Windows Embedded Standard 7E, Windows Embedded Standard 7P, Windows Embedded 8 Standard, Windows Embedded 8.1 Industry Pro, Windows 10 IOT Enterprise 2016 LTSC, and Windows 10 IoT Enterprise 2019.

[11] HP CEM requires Windows 10 IoT Enterprise LTSC 2016 or later or HP ThinPro 7.2 operating system or later on endpoint and Internet access. Visit <https://www.hp.com/us-en/solutions/cloud-computing/thin-client-software.html> to download or view the complete details, features and configuration requirements.

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